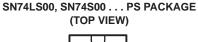
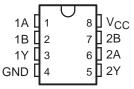
SDLS025B - DECEMBER 1983 - REVISED OCTOBER 2003

- Package Options Include Plastic Small-Outline (D, NS, PS), Shrink Small-Outline (DB), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs
- Also Available as Dual 2-Input Positive-NAND Gate in Small-Outline (PS) Package

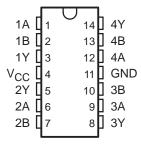
SN5400 . . . J PACKAGE SN54LS00, SN54S00 . . . J OR W PACKAGE SN7400, SN74S00 . . . D, N, OR NS PACKAGE SN74LS00 . . . D, DB, N, OR NS PACKAGE (TOP VIEW)

| 1A [<br>1B [<br>1Y [<br>2A [<br>2B [<br>2Y [<br>GND [ | 1<br>2<br>3<br>4<br>5<br>6<br>7 | V | 14<br>13<br>12<br>11<br>10<br>9 |   | V <sub>C</sub> (4B)<br>4A)<br>4Y)<br>3B)<br>3A)<br>3Y) | C |
|---|---------------------------------|---|---------------------------------|---|--|---|
|   |                                 |   |                                 | ı |  |   |

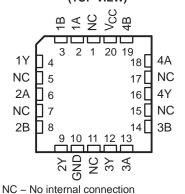




## SN5400 . . . W PACKAGE (TOP VIEW)



SN54LS00, SN54S00 . . . FK PACKAGE (TOP VIEW)



## description/ordering information

These devices contain four independent 2-input NAND gates. The devices perform the Boolean function  $Y = \overline{A} \bullet \overline{B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



## SDLS025B - DECEMBER 1983 - REVISED OCTOBER 2003

## description/ordering information (continued)

#### ORDERING INFORMATION

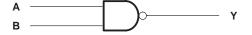
| TA             | PACK   | AGET          | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|--|---------------|--------------------------|---------------------|
|                |  |               | SN7400N                  | SN7400N             |
|                | PDIP – N   | Tube          | SN74LS00N                | SN74LS00N           |
|                |  |               | SN74S00N                 | SN74S00N            |
|                |  | Tube          | SN7400D                  | 7400                |
|                |  | Tape and reel | SN7400DR                 | 7400                |
|                | 0010 5   | Tube          | SN74LS00D                | 1.000               |
|                | SOIC - D   | Tape and reel | SN74LS00DR               | LS00                |
| 0°C to 70°C    |  | Tube          | SN74S00D                 | 000                 |
|                |  | Tape and reel | SN74S00DR                | S00                 |
|                |  |               | SN7400NSR                | SN7400              |
|                | SOP - NS   | Tape and reel | SN74LS00NSR              | 74LS00              |
|                |  |               | SN74S00NSR               | 74S00               |
|                | 000 00   |               | SN74LS00PSR              | LS00                |
|                | SOP - PS   | Tape and reel | SN74S00PSR               | S00                 |
|                | Tube   Tape and re   Tape and re   SOP – NS   Tape and re   SOP – DB   Tape and re   CDIP – J   Tube   Tu | Tape and reel | SN74LS00DBR              | LS00                |
|                |  |               | SNJ5400J                 | SNJ5400J            |
|                | CDIP – J   | Tube          | SNJ54LS00J               | SNJ54LS00J          |
|                |  |               | SNJ54S00J                | SNJ54S00J           |
| 5500 1- 40500  |  |               | SNJ5400W                 | SNJ5400W            |
| –55°C to 125°C | CFP – W  | Tube          | SNJ54LS00W               | SNJ54LS00W          |
|                |  |               | SNJ54S00W                | SNJ54S00W           |
|                | LCCC FK  | Tubo          | SNJ54LS00FK              | SNJ54LS00FK         |
|                |  |               | SNJ54S00FK               | SNJ54S00FK          |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

# FUNCTION TABLE (each gate)

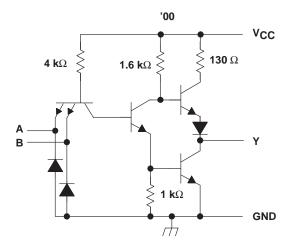
| INP | JTS | OUTPUT |
|-----|-----|--------|
| Α   | В   | Υ      |
| Н   | Н   | L      |
| L   | X   | Н      |
| Х   | L   | Н      |

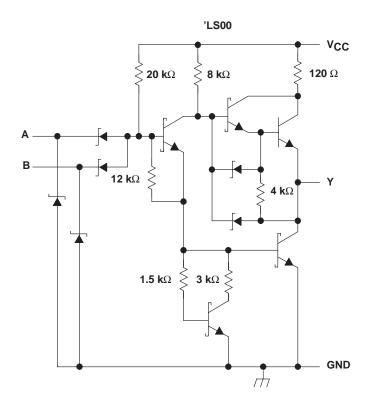
logic diagram, each gate (positive logic)

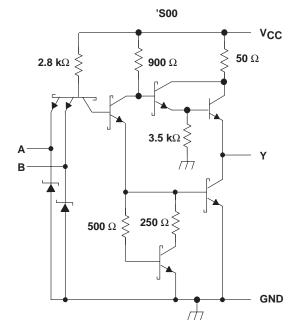




## schematic







Resistor values shown are nominal.

## SN5400, SN54LS00, SN54S00 SN7400, SN74LS00, SN74S00 QUADRUPLE 2-INPUT POSITIVE-NAND GATES SDLS025B - DECEMBER 1983 - REVISED OCTOBER 2003

absolute maximum ratings over operating free-air temperature (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1)            |            | 5.5 \         |
|---|------------|---------------|
| 'LS00   |            |               |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2) | D package  | 86°C/V        |
| •   | DB package | 96°C/V        |
|   | N package  | 80°C/V        |
|   | NS package |               |
|   | PS package | 95°C/V        |
| Storage temperature range, T <sub>stg</sub>             |            | 65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions (see Note 3)

|     |                                | ,   | SN5400 |      | ;    | SN7400 |      |      |
|-----|--------------------------------|-----|--------|------|------|--------|------|------|
|     |                                | MIN | NOM    | MAX  | MIN  | NOM    | MAX  | UNIT |
| Vcc | Supply voltage                 | 4.5 | 5      | 5.5  | 4.75 | 5      | 5.25 | V    |
| VIH | High-level input voltage       | 2   |        |      | 2    |        |      | V    |
| VIL | Low-level input voltage        |     |        | 0.8  |      |        | 0.8  | V    |
| ІОН | High-level output current      |     |        | -0.4 |      |        | -0.4 | mA   |
| loL | Low-level output current       |     |        | 16   |      |        | 16   | mA   |
| TA  | Operating free-air temperature | -55 |        | 125  | 0    |        | 70   | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  |                        |                         | 4                          |     | SN5400 |      |     | SN7400 |      |      |
|------------------|------------------------|-------------------------|----------------------------|-----|--------|------|-----|--------|------|------|
| PARAMETER        |                        | TEST CONDITIONS‡        |                            |     | TYP§   | MAX  | MIN | TYP§   | MAX  | UNIT |
| VIK              | V <sub>CC</sub> = MIN, | I <sub>I</sub> = -12 mA |                            |     |        | -1.5 |     |        | -1.5 | V    |
| Voн              | V <sub>CC</sub> = MIN, | $V_{IL} = 0.8 V$ ,      | $I_{OH} = -0.4 \text{ mA}$ | 2.4 | 3.4    |      | 2.4 | 3.4    |      | V    |
| VOL              | V <sub>CC</sub> = MIN, | V <sub>IH</sub> = 2 V,  | $I_{OL} = 16 \text{ mA}$   |     | 0.2    | 0.4  |     | 0.2    | 0.4  | V    |
| lį               | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 5.5 V  |                            |     |        | 1    |     |        | 1    | mA   |
| lіН              | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 2.4 V  |                            |     |        | 40   |     |        | 40   | μΑ   |
| Ι <sub>ΙL</sub>  | $V_{CC} = MAX$ ,       | $V_{I} = 0.4 \ V$       |                            |     |        | -1.6 |     |        | -1.6 | mA   |
| los¶             | V <sub>CC</sub> = MAX  |                         |                            | -20 |        | -55  | -18 |        | -55  | mA   |
| IССН             | V <sub>CC</sub> = MAX, | $V_I = 0 V$             |                            |     | 4      | 8    |     | 4      | 8    | mA   |
| <sup>I</sup> CCL | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 4.5 V  |                            |     | 12     | 22   |     | 12     | 22   | mA   |

<sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



NOTES: 1. Voltage values are with respect to network ground terminal.

<sup>2.</sup> The package termal impedance is calculated in accordance with JESD 51-7.

<sup>§</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>¶</sup> Not more than one output should be shorted at a time.

SDLS025B - DECEMBER 1983 - REVISED OCTOBER 2003

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

| PARAMETER        | FROM    | TO TEST CONDITIONS |                                    |     | SN5400<br>SN7400 |     |     |
|------------------|---------|--------------------|------------------------------------|-----|------------------|-----|-----|
|                  | (INPUT) | (001P01)           |                                    | MIN | TYP              | MAX |     |
| <sup>t</sup> PLH | A or B  | ٧                  | $R_L = 400 \Omega$ , $C_L = 15 pF$ |     | 11               | 22  | ns  |
| tPHL             | AOID    | '                  | TC = 400 32,                       |     | 7                | 15  | 113 |

#### recommended operating conditions (see Note 4)

|     |                                | S   | N54LS0 | )    | S    | N74LS0 | )    |      |
|-----|--------------------------------|-----|--------|------|------|--------|------|------|
|     |                                | MIN | NOM    | MAX  | MIN  | NOM    | MAX  | UNIT |
| VCC | Supply voltage                 | 4.5 | 5      | 5.5  | 4.75 | 5      | 5.25 | V    |
| VIH | High-level input voltage       | 2   |        |      | 2    |        |      | V    |
| VIL | Low-level input voltage        |     |        | 0.7  |      |        | 0.8  | V    |
| ЮН  | High-level output current      |     |        | -0.4 |      |        | -0.4 | mA   |
| loL | Low-level output current       |     |        | 4    |      |        | 8    | mA   |
| TA  | Operating free-air temperature | -55 |        | 125  | 0    |        | 70   | °C   |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  |                        |                         | 4                          | S   | N54LS0 | 0    | S   | N74LS0 | 0    |      |
|------------------|------------------------|-------------------------|----------------------------|-----|--------|------|-----|--------|------|------|
| PARAMETER        |                        | TEST CONDITIO           | ONST                       | MIN | TYP‡   | MAX  | MIN | TYP‡   | MAX  | UNIT |
| VIK              | V <sub>CC</sub> = MIN, | I <sub>I</sub> = -18 mA |                            |     |        | -1.5 |     |        | -1.5 | V    |
| Voн              | V <sub>CC</sub> = MIN, | $V_{IL} = MAX$ ,        | $I_{OH} = -0.4 \text{ mA}$ | 2.5 | 3.4    |      | 2.7 | 3.4    |      | V    |
|                  | N/ MINI                | V 2.V                   | $I_{OL} = 4 \text{ mA}$    |     | 0.25   | 0.4  |     | 0.25   | 0.4  | V    |
| VOL              | $V_{CC} = MIN,$        | V <sub>IH</sub> = 2 V   | $I_{OL} = 8mA$             |     |        |      |     | 0.35   | 0.5  | V    |
| lį               | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 7 V    |                            |     |        | 0.1  |     |        | 0.1  | mA   |
| lіН              | $V_{CC} = MAX$ ,       | $V_I = 2.7V$            |                            |     |        | 20   |     |        | 20   | μΑ   |
| I <sub>IL</sub>  | $V_{CC} = MAX$ ,       | $V_{I} = 0.4 \ V$       |                            |     |        | -0.4 |     |        | -0.4 | mA   |
| IOS§             | $V_{CC} = MAX$         |                         |                            | -20 |        | -100 | -20 |        | -100 | mA   |
| IССН             | V <sub>CC</sub> = MAX, | $V_I = 0 V$             | -                          |     | 0.8    | 1.6  |     | 0.8    | 1.6  | mA   |
| <sup>I</sup> CCL | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 4.5 V  |                            |     | 2.4    | 4.4  |     | 2.4    | 4.4  | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

| PARAMETER FROM (INPUT) |         | TO<br>(OUTPUT) | TEST C              | TEST CONDITIONS        |     |     | SN54LS00<br>SN74LS00 |     |  |  |
|------------------------|---------|----------------|---------------------|------------------------|-----|-----|----------------------|-----|--|--|
|                        | (INPOT) | (001F01)       |                     |                        | MIN | TYP | MAX                  |     |  |  |
| <sup>t</sup> PLH       | A or B  |                | $R_L = 2 k\Omega$ , | C <sub>I</sub> = 15 pF |     | 9   | 15                   | ns  |  |  |
| t <sub>PHL</sub>       | 7016    | ,              |                     | OL = 13 bi             |     | 10  | 15                   | 113 |  |  |



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time.

## SN5400, SN54LS00, SN54S00 SN7400, SN74LS00, SN74S00 QUADRUPLE 2-INPUT POSITIVE-NAND GATES

SDLS025B - DECEMBER 1983 - REVISED OCTOBER 2003

#### recommended operating conditions (see Note 5)

|     |                                | 5   | N54S00 |     | 5    | N74S00 | )    |      |
|-----|--------------------------------|-----|--------|-----|------|--------|------|------|
|     |                                | MIN | NOM    | MAX | MIN  | NOM    | MAX  | UNIT |
| Vcc | Supply voltage                 | 4.5 | 5      | 5.5 | 4.75 | 5      | 5.25 | V    |
| VIH | High-level input voltage       | 2   |        |     | 2    |        |      | V    |
| VIL | Low-level input voltage        |     |        | 0.8 |      |        | 0.8  | V    |
| ІОН | High-level output current      |     |        | -1  |      |        | -1   | mA   |
| lOL | Low-level output current       |     |        | 20  |      |        | 20   | mA   |
| TA  | Operating free-air temperature | -55 |        | 125 | 0    |        | 70   | °C   |

NOTE 5: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 |                  |                          |                          |                  | SN54S00 | )    | 5                | LINUT |      |    |
|-----------------|------------------|--------------------------|--------------------------|------------------|---------|------|------------------|-------|------|----|
| PARAMETER       | TEST CONDITIONS† |                          | MIN                      | TYP <sup>‡</sup> | MAX     | MIN  | TYP <sup>‡</sup> | MAX   | UNIT |    |
| VIK             | $V_{CC} = MIN,$  | $I_{I} = -18 \text{ mA}$ |                          |                  |         | -1.2 |                  |       | -1.2 | V  |
| Voн             | $V_{CC} = MIN,$  | $V_{IL} = 0.8 V$ ,       | $I_{OH} = -1 \text{ mA}$ | 2.5              | 3.4     |      | 2.7              | 3.4   |      | V  |
| V <sub>OL</sub> | $V_{CC} = MIN,$  | V <sub>IH</sub> = 2 V,   | $I_{OL} = 20 \text{ mA}$ |                  |         | 0.5  |                  |       | 0.5  | V  |
| l <sub>l</sub>  | $V_{CC} = MAX$ , | $V_{I} = 5.5 V$          |                          |                  |         | 1    |                  |       | 1    | mA |
| lіН             | $V_{CC} = MAX$ , | $V_1 = 2.7 \ V$          |                          |                  |         | 50   |                  |       | 50   | μΑ |
| I <sub>IL</sub> | $V_{CC} = MAX$ , | $V_{I} = 0.5V$           |                          |                  |         | -2   |                  |       | -2   | mA |
| los§            | $V_{CC} = MAX$   |                          |                          | -40              |         | -100 | -40              |       | -100 | mA |
| Іссн            | $V_{CC} = MAX$ , | $V_I = 0 V$              | •                        |                  | 10      | 16   |                  | 10    | 16   | mA |
| ICCL            | $V_{CC} = MAX$ , | V <sub>I</sub> = 4.5 V   | _                        |                  | 20      | 36   |                  | 20    | 36   | mA |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see Figure 1)

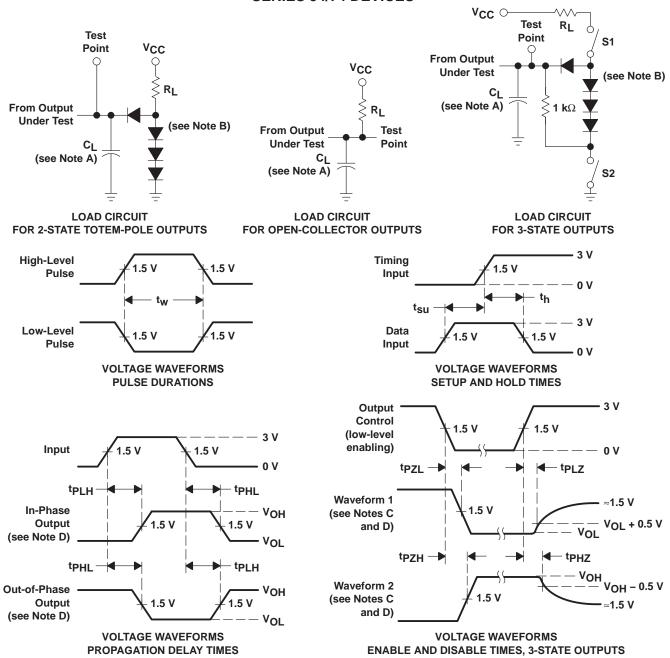
| PARAMETER        | FROM<br>(INPUT) | TO (OUTPUT) | TEST CO              | ONDITIONS              | s<br>s | UNIT |     |     |
|------------------|-----------------|-------------|----------------------|------------------------|--------|------|-----|-----|
|                  | (INPUT)         | (OUTPUT)    |                      | MIN                    | TYP    | MAX  |     |     |
| <sup>t</sup> PLH | A or B          |             | $R_1 = 280 \Omega$   | C <sub>I</sub> = 15 pF |        | 3    | 4.5 | ns  |
| <sup>t</sup> PHL | A 01 B          | '           | 11 = 200 32,         | OL = 13 pi             |        | 3    | 5   | 113 |
| <sup>t</sup> PLH | A or B          | V           | D. 200.0             | C <sub>I</sub> = 50 pF |        | 4.5  |     | ns  |
| <sup>t</sup> PHL | 7016            | '           | $R_L = 280 \Omega$ , | OL = 30 PF             |        | 5    |     |     |

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time.

SDLS025B - DECEMBER 1983 - REVISED OCTOBER 2003

#### PARAMETER MEASUREMENT INFORMATION **SERIES 54/74 DEVICES**



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_{\Omega} \approx 50 \Omega$ ;  $t_r$  and  $t_f \leq$  7 ns for Series 54/74 devices and  $t_r$  and  $t_f \le 2.5$  ns for Series 54S/74S devices.
  - F. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





www.ti.com 24-Jul-2010

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login)               |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|---|
| JM38510/00104BCA | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/00104BDA | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/07001BCA | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/07001BDA | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/30001B2A | ACTIVE                | LCCC         | FK                 | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/30001BCA | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/30001BDA | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/30001SCA | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| JM38510/30001SDA | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| SN5400J          | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| SN54LS00J        | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| SN54S00J         | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples                          |
| SN7400D          | ACTIVE                | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                          |
| SN7400DE4        | ACTIVE                | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                          |
| SN7400DG4        | ACTIVE                | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                          |
| SN7400N          | ACTIVE                | PDIP         | N                  | 14   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           | Contact TI Distributor or Sales Office    |
| SN7400N3         | OBSOLETE              | PDIP         | N                  | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Available                     |
| SN7400NE4        | ACTIVE                | PDIP         | N                  | 14   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           | Contact TI Distributor or Sales Office    |
| SN74LS00D        | ACTIVE                | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Contact TI Distributor<br>or Sales Office |
| SN74LS00DBLE     | OBSOLETE              | SSOP         | DB                 | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Available                     |
| SN74LS00DBR      | ACTIVE                | SSOP         | DB                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                          |
| SN74LS00DBRE4    | ACTIVE                | SSOP         | DB                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                          |
| SN74LS00DBRG4    | ACTIVE                | SSOP         | DB                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                          |



24-Jul-2010

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login)           |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|---------------------------------------|
| SN74LS00DE4      | ACTIVE                | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Contact TI Distributo or Sales Office |
| SN74LS00DG4      | ACTIVE                | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Contact TI Distributo or Sales Office |
| SN74LS00DR       | ACTIVE                | SOIC         | D                  | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00DRE4     | ACTIVE                | SOIC         | D                  | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00DRG4     | ACTIVE                | SOIC         | D                  | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00J        | OBSOLETE              | CDIP         | J                  | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Availab                   |
| SN74LS00N        | ACTIVE                | PDIP         | N                  | 14   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           | Contact TI Distribute or Sales Office |
| SN74LS00NE4      | ACTIVE                | PDIP         | N                  | 14   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           | Contact TI Distribute or Sales Office |
| SN74LS00NSR      | ACTIVE                | SO           | NS                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00NSRG4    | ACTIVE                | SO           | NS                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00PSR      | ACTIVE                | SO           | PS                 | 8    | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00PSRE4    | ACTIVE                | SO           | PS                 | 8    | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74LS00PSRG4    | ACTIVE                | SO           | PS                 | 8    | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples                      |
| SN74S00D         | NRND                  | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Samples Not Availab                   |
| SN74S00DE4       | NRND                  | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Samples Not Availab                   |
| SN74S00DG4       | NRND                  | SOIC         | D                  | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Samples Not Availab                   |
| SN74S00DR        | NRND                  | SOIC         | D                  | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Availab                   |
| SN74S00DRE4      | NRND                  | SOIC         | D                  | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Availab                   |
| SN74S00DRG4      | NRND                  | SOIC         | D                  | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Availab                   |
| SN74S00N         | NRND                  | PDIP         | N                  | 14   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           | Samples Not Availab                   |





www.ti.com 24-Jul-2010

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| SN74S00N3        | OBSOLETE              | PDIP         | N                  | 14   |             | TBD                        | Call TI              | Call TI                      | Samples Not Available       |
| SN74S00NE4       | NRND                  | PDIP         | N                  | 14   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           | Samples Not Available       |
| SN74S00NSR       | ACTIVE                | SO           | NS                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples            |
| SN74S00NSRE4     | ACTIVE                | SO           | NS                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples            |
| SN74S00NSRG4     | ACTIVE                | SO           | NS                 | 14   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           | Purchase Samples            |
| SNJ5400J         | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples            |
| SNJ5400W         | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples            |
| SNJ5400WA        | OBSOLETE              | CFP          | WA                 | 14   |             | TBD                        | A42                  | N / A for Pkg Type           | Samples Not Available       |
| SNJ54LS00FK      | ACTIVE                | LCCC         | FK                 | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           | Purchase Samples            |
| SNJ54LS00J       | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples            |
| SNJ54LS00W       | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples            |
| SNJ54S00FK       | ACTIVE                | LCCC         | FK                 | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           | Purchase Samples            |
| SNJ54S00J        | ACTIVE                | CDIP         | J                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples            |
| SNJ54S00W        | ACTIVE                | CFP          | W                  | 14   | 1           | TBD                        | A42                  | N / A for Pkg Type           | Purchase Samples            |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



## **PACKAGE OPTION ADDENDUM**



24-Jul-2010

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN5400, SN54LS00, SN54LS00-SP, SN54S00, SN7400, SN74LS00, SN74S00:

• Catalog: SN7400, SN74LS00, SN54LS00, SN74S00

Military: SN5400, SN54LS00, SN54S00

Space: SN54LS00-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2010

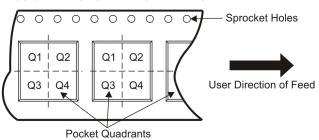
## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                     | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74LS00DBR                | SSOP            | DB                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 6.6        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LS00DR                 | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LS00NSR                | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LS00PSR                | SO              | PS                 | 8  | 2000 | 330.0                    | 16.4                     | 8.2        | 6.6        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74S00NSR                 | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |

www.ti.com 23-Jul-2010



\*All dimensions are nominal

| 7 til dilliciololio are nominal |              |                 |      |      |             |            |             |
|---------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74LS00DBR                     | SSOP         | DB              | 14   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74LS00DR                      | SOIC         | D               | 14   | 2500 | 346.0       | 346.0      | 33.0        |
| SN74LS00NSR                     | SO           | NS              | 14   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74LS00PSR                     | SO           | PS              | 8    | 2000 | 346.0       | 346.0      | 33.0        |
| SN74S00NSR                      | SO           | NS              | 14   | 2000 | 346.0       | 346.0      | 33.0        |

## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



## D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products                    |                        | Applications                 |                                   |
|-----------------------------|------------------------|------------------------------|-----------------------------------|
| Amplifiers                  | amplifier.ti.com       | Audio                        | www.ti.com/audio                  |
| Data Converters             | dataconverter.ti.com   | Automotive                   | www.ti.com/automotive             |
| DLP® Products               | www.dlp.com            | Communications and Telecom   | www.ti.com/communications         |
| DSP                         | <u>dsp.ti.com</u>      | Computers and<br>Peripherals | www.ti.com/computers              |
| Clocks and Timers           | www.ti.com/clocks      | Consumer Electronics         | www.ti.com/consumer-apps          |
| Interface                   | interface.ti.com       | Energy                       | www.ti.com/energy                 |
| Logic                       | logic.ti.com           | Industrial                   | www.ti.com/industrial             |
| Power Mgmt                  | power.ti.com           | Medical                      | www.ti.com/medical                |
| Microcontrollers            | microcontroller.ti.com | Security                     | www.ti.com/security               |
| RFID                        | www.ti-rfid.com        | Space, Avionics & Defense    | www.ti.com/space-avionics-defense |
| RF/IF and ZigBee® Solutions | www.ti.com/lprf        | Video and Imaging            | www.ti.com/video                  |
|                             |                        | Wireless                     | www.ti.com/wireless-apps          |